

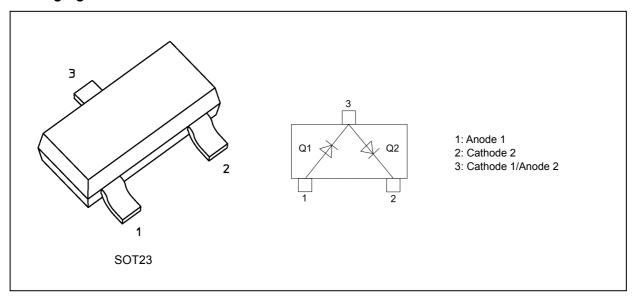
Switching Diodes Silicon Epitaxial Planar

# **BAV99**

#### 1. Applications

· Ultra-High-Speed Switching

## 2. Packaging and Internal Circuit



# 3. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Rating	Unit
Peak reverse voltage	$V_{RM}$		100	V
Reverse voltage	V <sub>R</sub>		100	
Peak forward current	I <sub>FM</sub>	(Note 1)	500	mA
Average rectified current	I <sub>O</sub>	(Note 2)	215	mA
Non-repetitive peak forward surge current	I <sub>FSM</sub>	(Note 3)	2	Α
Power dissipation	P <sub>D</sub>		150	mW
		(Note 4)	320	
Junction temperature	Tj		150	°C
Storage temperature	T <sub>stg</sub>		-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Unit rating. Total rating = Unit rating × 40%

Note 2: Unit rating. Total rating = Unit rating  $\times$  55%

Note 3: Pulse width 10 ms

Note 4: Mounted on an FR4 board (25.4 mm  $\times$  25.4 mm  $\times$  1.6 mmt, Cu pad: 0.42 mm<sup>2</sup>  $\times$  3)

Start of commercial production

2016-08



#### 4. Thermal Characteristics

Characteristics		Symbol	Max	Unit
Junction-to-ambient thermal resistance	(Note 1)	R <sub>th(j-a)</sub>	391	°C/W

Note 1: Mounted on an FR4 board (25.4 mm  $\times$  25.4 mm  $\times$  1.6 mmt, Cu pad: 0.42 mm<sup>2</sup>  $\times$  3)

## 5. Electrical Characteristics (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V <sub>F</sub> (1)	I <sub>F</sub> = 1 mA	_	_	0.715	V
	V <sub>F</sub> (2)	I <sub>F</sub> = 10 mA		_	0.855	
	V <sub>F</sub> (3)	I <sub>F</sub> = 50 mA	_	_	1.0	
	V <sub>F</sub> (4)	I <sub>F</sub> = 150 mA	_	_	1.25	
Reverse current	I <sub>R</sub> (1)	V <sub>R</sub> = 25 V	_	_	30	nA
	I <sub>R</sub> (2)	V <sub>R</sub> = 80 V	_	_	200	
Total capacitance	C <sub>t</sub>	V <sub>R</sub> = 0 V, f = 1 MHz	_	0.9	_	pF
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 10 mA, See Fig. 5.1	_	_	3.0	ns

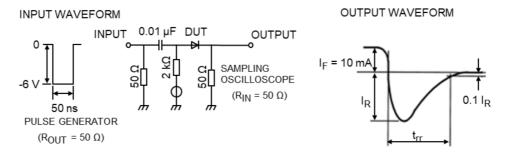
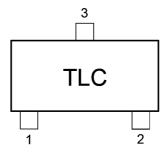


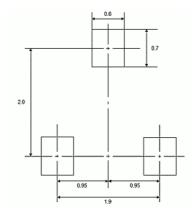
Fig. 5.1 Reverse recovery time (t<sub>rr</sub>) Test circuit

## 6. Marking





# 7. Land Pattern Dimensions (for reference only)



SOT23 (Unit: mm)



### 8. Characteristics Curves (Note)

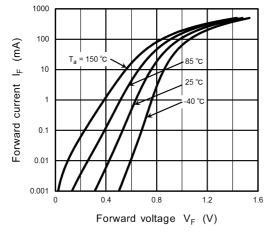


Fig. 8.1 I<sub>F</sub> - V<sub>F</sub>

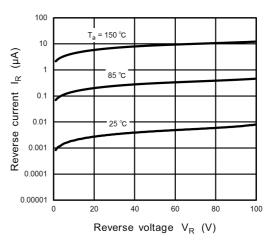


Fig. 8.2 I<sub>R</sub> - V<sub>R</sub>

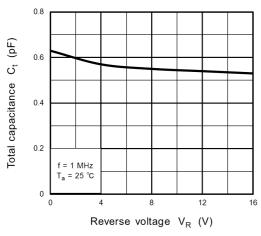


Fig. 8.3 Ct - VR

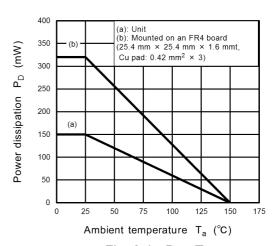


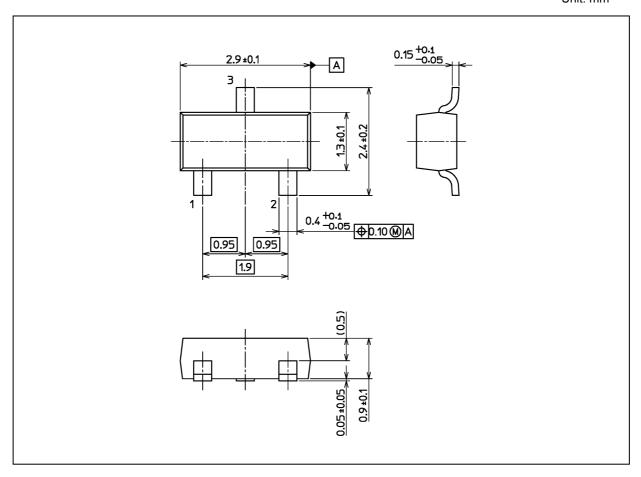
Fig. 8.4 PD - Ta

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



## **Package Dimensions**

Unit: mm



Weight: 9 mg (typ.)

	Package Name(s)
JEDEC: SOT-23	
Nickname: SOT23	



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